



Dual N-Channel 190-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A) ^a	Q _g (Typ.)			
	3.8 at V _{GS} = 4.5 V	0.95				
190	4.2 at V _{GS} = 2.5 V	0.9	1.4 nC			
	17 at V _{GS} = 1.8 V	0.3				

FEATURES

- Halogen-free According to IEC 61249-2-21
- LITTLE FOOT® Power MOSFET
- New Thermally Enhanced PowerPAK® SC-70 Package
 - Small Footprint Area
 - Low On-Resistance
 - Thin 0.75 mm profile

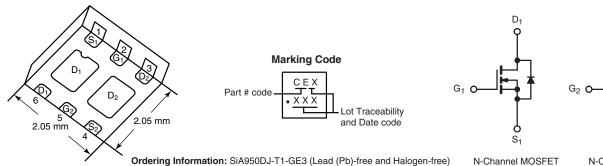


COMPLIANT HALOGEN FREE

APPLICATIONS

- DC/DC Converter for Portable Devices
- · Load Switch for Portable Devices

PowerPAK SC-70-6 Dual





N-Channel MOSFET

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	190	V	
Gate-Source Voltage		V _{GS}	± 16	V	
	T _C = 25 °C		0.95		
Continuous Drain Current (T, = 150 °C)	T _C = 70 °C		0.76		
Continuous Brain Guiterit (1) = 130 C)	T _A = 25 °C	l _D	0.47 ^{b, c}		
	T _A = 70 °C]	0.38 ^{b, c}	A	
Pulsed Drain Current		I _{DM}	1		
Continuous Source-Drain Diode Current	T _C = 25 °C	I-	0.95		
	T _A = 25 °C	l _S	0.47 ^{b, c}		
	T _C = 25 °C		7		
Marian and Danier Displacements	T _C = 70 °C	P_{D}	5	w	
Maximum Power Dissipation	T _A = 25 °C	' Б	1.9 ^{b, c}	VV	
	T _A = 70 °C]	1.2 ^{b, c}		
Operating Junction and Storage Temperature Re	T _J , T _{stg}	- 55 to 150	°C		
Soldering Recommendations (Peak Temperatur		260			

SiA950DJ

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THERMAL RESISTANCE RATINGS								
Parameter	Symbol	Typical	Maximum	Unit				
Maximum Junction-to-Ambient ^{b, f}	t ≤ 5 s	R_{thJA}	52	65	°C/W			
Maximum Junction-to-Case (Drain)	Steady State	R_{thJC}	12.5	16	O/ VV			

Notes:

- a. $T_C = 25$ °C.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 5 s.
- d. See Solder Profile (www.vishay.com/ppg?73257). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under Steady State conditions is 110 °C/W.

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	190			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	J 050 A		200		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	$I_{D} = 250 \ \mu A$		- 3.0			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	0.6		1.4	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 16 \text{ V}$			± 100	nA	
Zero Coto Valtono Duein Comuna		V _{DS} = 190 V, V _{GS} = 0 V			1	μА	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 190 V, V _{GS} = 0 V, T _J = 85 °C			10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	1			Α	
		$V_{GS} = 4.5 \text{ V}, I_D = 0.36 \text{ A}$		3.0	3.8		
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 2.5 \text{ V}, I_D = 0.35 \text{ A}$		3.2	4.2	Ω	
		$V_{GS} = 1.8 \text{ V}, I_D = 0.15 \text{ A}$		3.5	17.0	ĺ	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 0.36 A		2		S	
Dynamic ^b							
Input Capacitance	C _{iss}			90		pF	
Output Capacitance	C _{oss}	$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		5			
Reverse Transfer Capacitance	C _{rss}			3			
Total Gate Charge	Q_g $V_{DS} = 95 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 0.47 \text{ A}$ $V_{DS} = 95 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 0.47 \text{ A}$	$V_{DS} = 95 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 0.47 \text{ A}$		3	4.5	nC	
Total Gate Charge				1.4	2.1		
Gate-Source Charge			0.25				
Gate-Drain Charge	Q_gd			0.40			
Gate Resistance	R_{g}	f = 1 MHz		2.3		Ω	
Turn-On Delay Time	t _{d(on)}			10	15		
Rise Time	t _r	V_{DD} = 95 V, R_L = 250 Ω		15	25	ĺ	
Turn-Off DelayTime	t _{d(off)}	$I_D \cong 0.38 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		25	40		
Fall Time	t _f			15	25	nc	
Turn-On Delay Time	t _{d(on)}			3	10	ns	
Rise Time	t _r	V_{DD} = 95 V, R_L = 250 Ω		12	20	ĺ	
Turn-Off DelayTime	t _{d(off)}	$I_D\cong~0.38~A,~V_{GEN}=10~V,~R_g=1~\Omega$		10	15		
Fall Time	t _f			10	15		
Drain-Source Body Diode Characteristi	cs						
Continuous Source-Drain Diode Current	I _S	I _S			0.95	Α	
Pulse Diode Forward Current	I _{SM}				1	^	
Body Diode Voltage	V_{SD}	I _S = 0.5 A, V _{GS} = 0 V		0.8	1.2	V	



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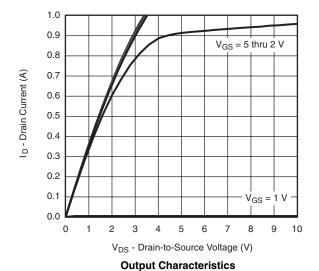
SPECIFICATIONS $T_J = 25$ °C, unless otherwise noted								
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit		
Drain-Source Body Diode Characteristics								
Body Diode Reverse Recovery Time	t _{rr}			45	70	ns		
Body Diode Reverse Recovery Charge	Q_{rr}	I _F = 0.5 A, dl/dt = 100 A/μs, T _{.1} = 25 °C		45	70	nC		
Reverse Recovery Fall Time	t _a	1 - 0.3 Α, αι/αι - 100 Α/μ3, 1 - 23 0		21		ns		
Reverse Recovery Rise Time	t _b			24		113		

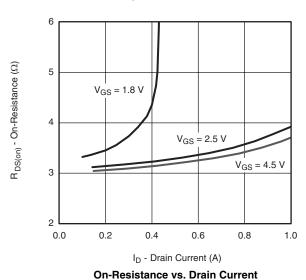
Notes:

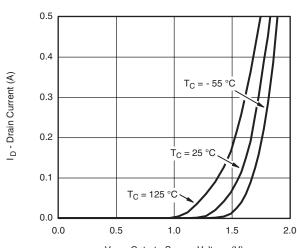
- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS $T_A = 25$ °C, unless otherwise noted

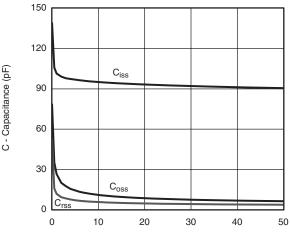






V_{GS} - Gate-to-Source Voltage (V)

Transfer Characteristics



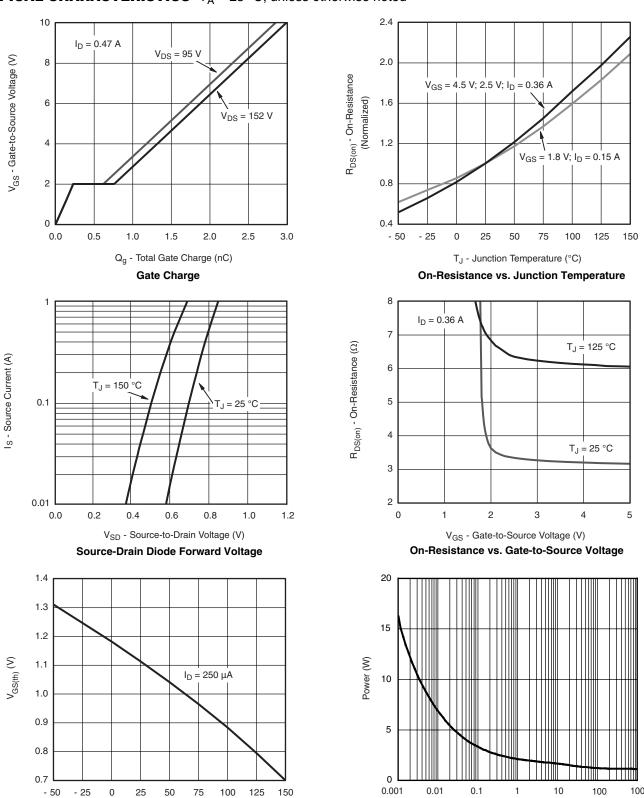
V_{DS} - Drain-to-Source Voltage (V)

Capacitance

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TYPICAL CHARACTERISTICS $T_A = 25$ °C, unless otherwise noted



T_J - Temperature (°C)

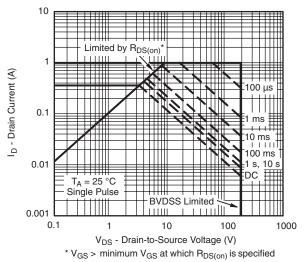
Threshold Voltage

Pulse (s)

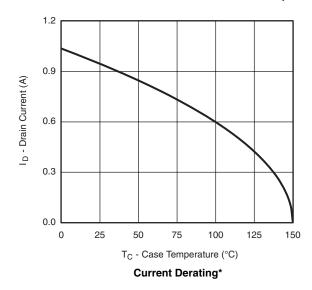
Single Pulse Power (Junction-to-Ambient)

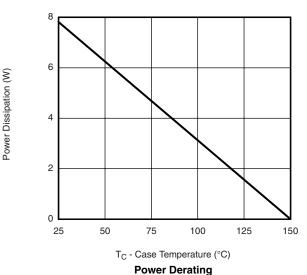


TYPICAL CHARACTERISTICS $T_A = 25$ °C, unless otherwise noted



Safe Operating Area, Junction-to-Ambient



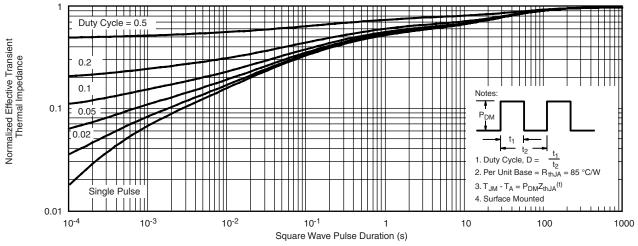


^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

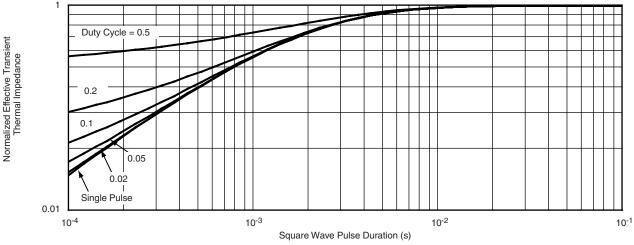
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TYPICAL CHARACTERISTICS $T_A = 25$ °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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